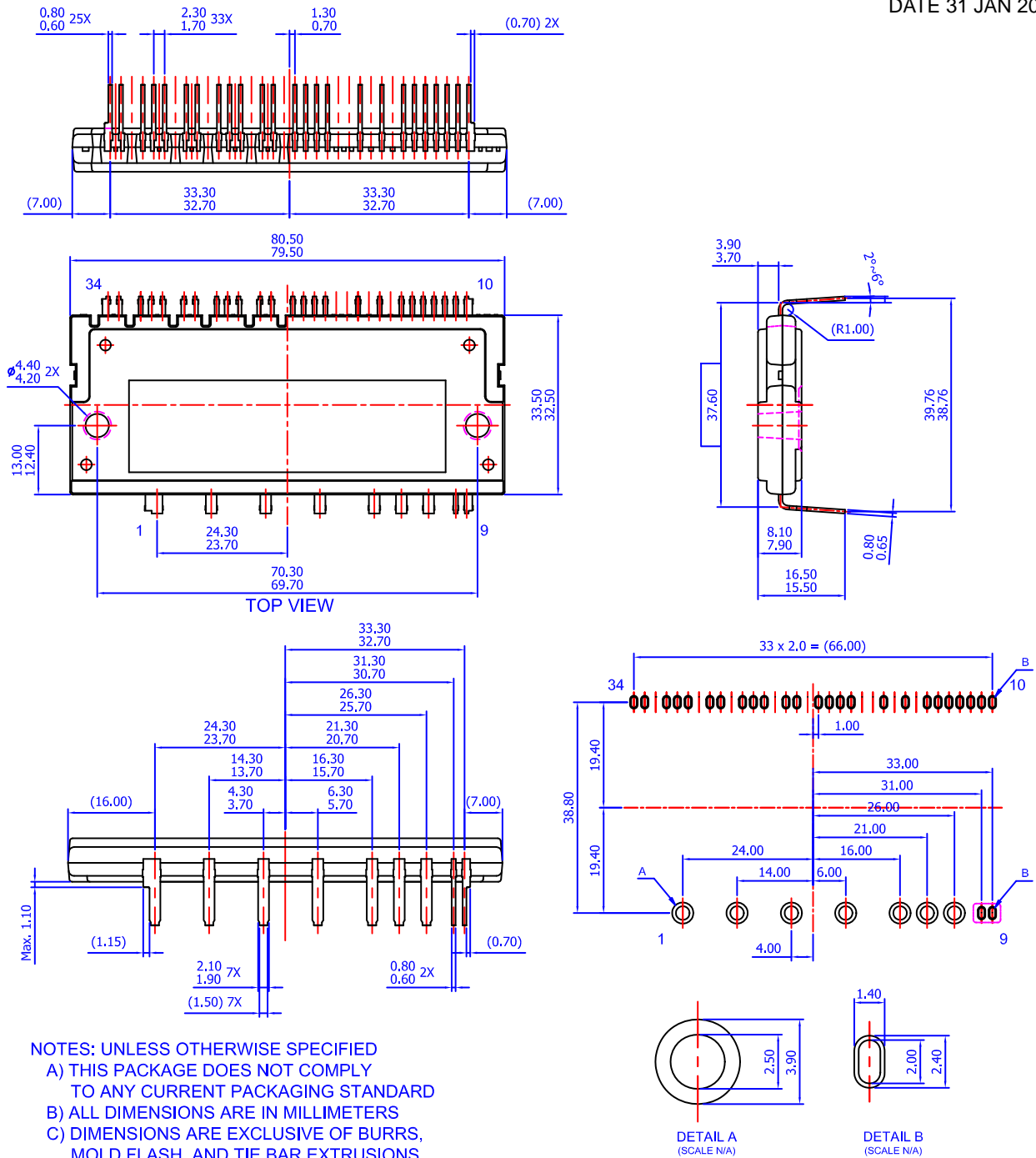


SPMCA-A34 / 34LD, PDD STD, DBC DIP TYPE  
CASE MODFQ  
ISSUE O

DATE 31 JAN 2017



- NOTES: UNLESS OTHERWISE SPECIFIED
- A) THIS PACKAGE DOES NOT COMPLY TO ANY CURRENT PACKAGING STANDARD
  - B) ALL DIMENSIONS ARE IN MILLIMETERS
  - C) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS
  - D) PACKAGE SURFACE VOID SHALL NOT EXCEED 2.3 x 2.3 x 1.0mm
  - E) ( ) IS REFERENCE

LAND PATTERN RECOMMENDATIONS

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